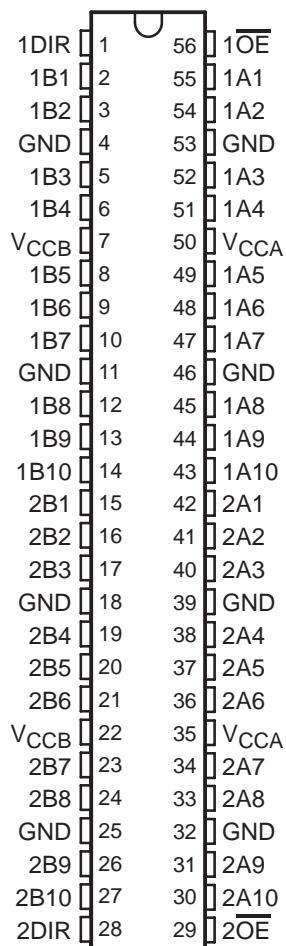


SN74AVCH20T245
20-BIT DUAL-SUPPLY BUS TRANSCEIVER
WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

SCES567F – MAY 2004 – REVISED APRIL 2005

- Control Inputs V_{IH}/V_{IL} Levels are Referenced to V_{CCA} Voltage
- V_{CC} Isolation Feature – If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance State
- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- I_{off} Supports Partial-Power-Down Mode Operation
- I/Os Are 4.6-V Tolerant
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Max Data Rates
 - 380 Mbps (1.8-V to 3.3-V Translation)
 - 260 Mbps (< 1.8-V to 3.3-V Translation)
 - 260 Mbps (Translate to 2.5 V)
 - 210 Mbps (Translate to 1.8 V)
 - 120 Mbps (Translate to 1.5 V)
 - 100 Mbps (Translate to 1.2 V)
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 8000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DGG OR DGV PACKAGE
(TOP VIEW)



description/ordering information

This 20-bit noninverting bus transceiver uses two separate configurable power-supply rails. The SN74AVCH20T245 is optimized to operate with V_{CCA}/V_{CCB} set at 1.4 V to 3.6 V. It is operational with V_{CCA}/V_{CCB} as low as 1.2 V. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.6-V voltage nodes.

ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	TSSOP – DGG	Tape and reel	SN74AVCH20T245GR	AVCH20T245
	TVSOP – DGV	Tape and reel	SN74AVCH20T245VR	WK245
	VFBGA – GQL	Tape and reel	SN74AVCH20T245KR	WK245
	VFBGA – ZQL (Pb-free)		74AVCH20T245ZQLR	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2005, Texas Instruments Incorporated

SN74AVCH20T245

20-BIT DUAL-SUPPLY BUS TRANSCEIVER

WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

SCES567F – MAY 2004 – REVISED APRIL 2005

description/ordering information (continued)

The SN74AVCH20T245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the outputs so that the buses are effectively isolated.

The SN74AVCH20T245 is designed so that the control (1DIR, 2DIR, $1\overline{OE}$, and $2\overline{OE}$) inputs are supplied by V_{CCA} .

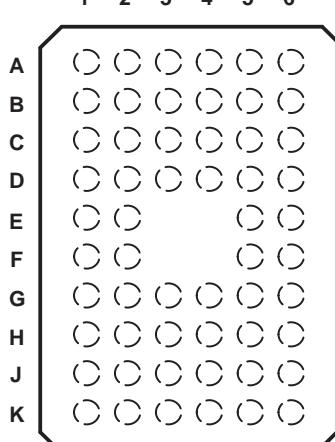
This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, both outputs are in the high-impedance state. The bus-hold circuitry on the powered-up side always stays active.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

**GQL OR ZQL PACKAGE
(TOP VIEW)**



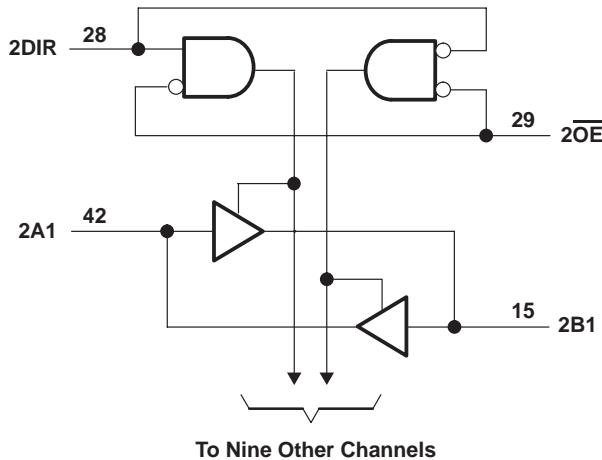
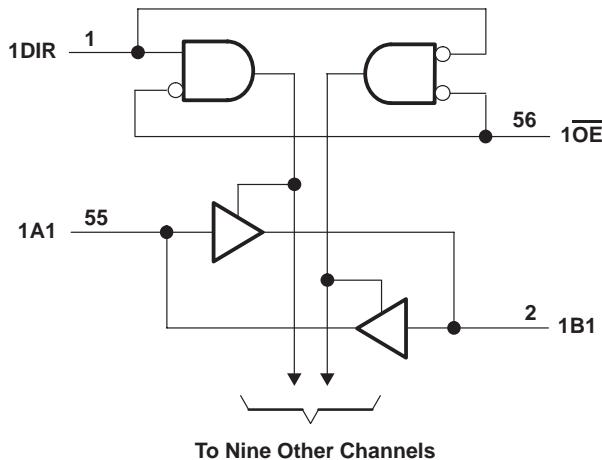
terminal assignments

	1	2	3	4	5	6
A	1B1	1B2	1DIR	$1\overline{OE}$	1A2	1A1
B	1B3	1B4	GND	GND	1A4	1A3
C	1B5	1B6	V_{CCB}	V_{CCA}	1A6	1A5
D	1B7	1B8	GND	GND	1A8	1A7
E	1B9	1B10			1A10	1A9
F	2B1	2B2			2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
H	2B5	2B6	V_{CCB}	V_{CCA}	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
K	2B9	2B10	2DIR	$2\overline{OE}$	2A10	2A9

**FUNCTION TABLE
(each 10-bit section)**

INPUTS		OPERATION
\overline{OE}	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

logic diagram (positive logic)



Pin numbers shown are for the DGG and DGV packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
 2. The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

SN74AVCH20T245**20-BIT DUAL-SUPPLY BUS TRANSCEIVER****WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS**

SCES567F – MAY 2004 – REVISED APRIL 2005

recommended operating conditions (see Notes 4 through 8)

		V _{CCI}	V _{CCO}	MIN	MAX	UNIT
V _{CCA}	Supply voltage			1.2	3.6	V
V _{CCB}	Supply voltage			1.2	3.6	V
V _{IH}	High-level input voltage	Data inputs (see Note 7)	1.2 V to 1.95 V		V _{CCI} × 0.65	V
			1.95 V to 2.7 V		1.6	
			2.7 V to 3.6 V		2	
V _{IL}	Low-level input voltage	Data inputs (see Note 7)	1.2 V to 1.95 V		V _{CCI} × 0.35	V
			1.95 V to 2.7 V		0.7	
			2.7 V to 3.6 V		0.8	
V _{IH}	High-level input voltage	DIR (referenced to V _{CCA}) (see Note 8)	1.2 V to 1.95 V		V _{CCA} × 0.65	V
			1.95 V to 2.7 V		1.6	
			2.7 V to 3.6 V		2	
V _{IL}	Low-level input voltage	DIR (referenced to V _{CCA}) (see Note 8)	1.2 V to 1.95 V		V _{CCA} × 0.35	V
			1.95 V to 2.7 V		0.7	
			2.7 V to 3.6 V		0.8	
V _I	Input voltage			0	3.6	V
V _O	Output voltage	Active state		0	V _{CCO}	V
		3-state		0	3.6	
I _{OH}	High-level output current		1.2 V		-3	mA
			1.4 V to 1.6 V		-6	
			1.65 V to 1.95 V		-8	
			2.3 V to 2.7 V		-9	
			3 V to 3.6 V		-12	
I _{OL}	Low-level output current		1.2 V		3	mA
			1.4 V to 1.6 V		6	
			1.65 V to 1.95 V		8	
			2.3 V to 2.7 V		9	
			3 V to 3.6 V		12	
Δt/Δv	Input transition rise or fall rate				5	ns/V
T _A	Operating free-air temperature			-40	85	°C

NOTES: 4. V_{CCI} is the V_{CC} associated with the data input port.
 5. V_{CCO} is the V_{CC} associated with the output port.
 6. All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
 7. For V_{CCI} values not specified in the data sheet, V_{IH(min)} = V_{CCI} × 0.7 V, V_{IL(max)} = V_{CCI} × 0.3 V.
 8. For V_{CCI} values not specified in the data sheet, V_{IH(min)} = V_{CCA} × 0.7 V, V_{IL(max)} = V_{CCA} × 0.3 V.

SN74AVCH20T245
20-BIT DUAL-SUPPLY BUS TRANSCEIVER
WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS
SCES567F – MAY 2004 – REVISED APRIL 2005

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Note 9)

PARAMETER	TEST CONDITIONS	V _{CCA}	V _{CCB}	T _A = 25°C			-40°C to 85°C		UNIT
				MIN	TYP	MAX	MIN	MAX	
V _{OH}	I _{OH} = -100 µA	V _I = V _{IH}	1.2 V to 3.6 V	1.2 V to 3.6 V			V _{CCO} – 0.2 V		V
	I _{OH} = -3 mA		1.2 V	1.2 V	0.95				
	I _{OH} = -6 mA		1.4 V	1.4 V			1.05		
	I _{OH} = -8 mA		1.65 V	1.65 V			1.2		
	I _{OH} = -9 mA		2.3 V	2.3 V			1.75		
	I _{OH} = -12 mA		3 V	3 V			2.3		
V _{OL}	I _{OL} = 100 µA	V _I = V _{IL}	1.2 V to 3.6 V	1.2 V to 3.6 V			0.2		V
	I _{OL} = 3 mA		1.2 V	1.2 V	0.15				
	I _{OL} = 6 mA		1.4 V	1.4 V			0.35		
	I _{OL} = 8 mA		1.65 V	1.65 V			0.45		
	I _{OL} = 9 mA		2.3 V	2.3 V			0.55		
	I _{OL} = 12 mA		3 V	3 V			0.7		
I _I	Control inputs	V _I = V _{CCA} or GND	1.2 V to 3.6 V	1.2 V to 3.6 V	±0.025	±0.25		±1	µA
I _{BHL} [†]	V _I = 0.42 V		1.2 V	1.2 V	25				µA
	V _I = 0.49 V		1.4 V	1.4 V			15		
	V _I = 0.58 V		1.65 V	1.65 V			25		
	V _I = 0.7 V		2.3 V	2.3 V			45		
	V _I = 0.8 V		3.3 V	3.3 V			100		
I _{BHH} [‡]	V _I = 0.78 V		1.2 V	1.2 V	-25				µA
	V _I = 0.91 V		1.4 V	1.4 V			-15		
	V _I = 1.07 V		1.65 V	1.65 V			-25		
	V _I = 1.6 V		2.3 V	2.3 V			-45		
	V _I = 2 V		3.3 V	3.3 V			-100		
I _{BHLO} [§]	V _I = 0 to V _{CC}	1.2 V	1.2 V	50					µA
		1.6 V	1.6 V				125		
		1.95 V	1.95 V				200		
		2.7 V	2.7 V				300		
		3.6 V	3.6 V				500		
I _{BHHO} [¶]	V _I = 0 to V _{CC}	1.2 V	1.2 V	-50					µA
		1.6 V	1.6 V				-125		
		1.95 V	1.95 V				-200		
		2.7 V	2.7 V				-300		
		3.6 V	3.6 V				-500		

[†] The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND and then raising it to V_{IL} max.

[‡] The bus-hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_{IN} to V_{CC} and then lowering it to V_{IH} min.

[§] An external driver must source at least I_{BHLO} to switch this node from low to high.

[¶] An external driver must sink at least I_{BHHO} to switch this node from high to low.

NOTE 9: V_{CCO} is the V_{CC} associated with the output port.

SN74AVCH20T245**20-BIT DUAL-SUPPLY BUS TRANSCEIVER****WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS**

SCES567F – MAY 2004 – REVISED APRIL 2005

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Notes 10 and 11) (continued)

PARAMETER		TEST CONDITIONS		V _{CCA}	V _{CCB}	T _A = 25°C			-40°C to 85°C		UNIT
						MIN	TYP	MAX	MIN	MAX	
I _{off}	A port	V _I or V _O = 0 to 3.6 V		0 V	0 to 3.6 V	±0.1	±1		±5		μA
	B port			0 to 3.6 V	0 V	±0.1	±1		±5		
I _{OZ} [†]	A or B ports	V _O = V _{CCO} or GND, V _I = V _{CCI} or GND	OE = V _{IH}	3.6 V	3.6 V	±0.5	±2.5		±5		μA
	B port			0 V	3.6 V				±5		
	A port			3.6 V	0 V				±5		
I _{CCA}		V _I = V _{CCI} or GND, I _O = 0		1.2 V to 3.6 V	1.2 V to 3.6 V				35		μA
				0 V	3.6 V				-5		
				3.6 V	0 V				35		
I _{CCB}		V _I = V _{CCI} or GND, I _O = 0		1.2 V to 3.6 V	1.2 V to 3.6 V				35		μA
				0 V	3.6 V				35		
				3.6 V	0 V				-5		
I _{CCA} + I _{CCB}	V _I = V _{CCI} or GND, I _O = 0			1.2 V to 3.6 V	1.2 V to 3.6 V				65	μA	
C _i	Control inputs	V _I = 3.3 V or GND		3.3 V	3.3 V	3.5				pF	
C _{io}	A or B ports	V _O = 3.3 V or GND		3.3 V	3.3 V	7				pF	

[†] For I/O ports, the parameter I_{OZ} includes the input leakage current.

NOTES: 10. V_{CCO} is the V_{CC} associated with the output port.

11. V_{CCI} is the V_{CC} associated with the input port.

switching characteristics over recommended operating free-air temperature range, V_{CCA} = 1.2 V (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V	V _{CCB} = 1.8 V	V _{CCB} = 2.5 V	V _{CCB} = 3.3 V	UNIT
			TYP	TYP	TYP	TYP	TYP	
t _{PLH}	A	B	3.8	3.1	2.8	2.7	3.3	ns
			3.8	3.1	2.8	2.7	3.3	
t _{PHL}	B	A	4.1	3.8	3.6	3.5	3.4	ns
			4.1	3.8	3.6	3.5	3.4	
t _{PZH}	OE	A	6.5	6.5	6.5	6.5	6.5	ns
			6.5	6.5	6.5	6.5	6.5	
t _{PZL}	OE	B	5.6	4.4	3.8	3.3	3.2	ns
			5.6	4.4	3.8	3.3	3.2	
t _{PHZ}	OE	A	6.4	6.4	6.4	6.4	6.4	ns
			6.4	6.4	6.4	6.4	6.4	
t _{PLZ}	OE	B	5.7	4.6	4.7	4.1	5.4	ns
			5.7	4.6	4.7	4.1	5.4	

SN74AVCH20T245
20-BIT DUAL-SUPPLY BUS TRANSCEIVER
WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS
SCES567F – MAY 2004 – REVISED APRIL 2005

switching characteristics over recommended operating free-air temperature range,
 $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
tPLH	A	B	3.8	0.5	6.4	0.5	5.4	0.5	4.3	0.5	3.9	ns
tPHL			3.8	0.5	6.4	0.5	5.4	0.5	4.3	0.5	3.9	
tPLH	B	A	3.1	0.5	6.4	0.5	6.1	0.5	5.8	0.5	5.7	ns
tPHL			3.1	0.5	6.4	0.5	6.1	0.5	5.8	0.5	5.7	
tPZH	\overline{OE}	A	4.3	1.5	10.3	1.5	10.3	1.5	10.2	1.5	10.2	ns
tPZL			4.3	1.5	10.3	1.5	10.3	1.5	10.2	1.5	10.2	
tPZH	\overline{OE}	B	5.2	1	10.3	1	8.4	0.5	6.1	0.5	5.3	ns
tPZL			5.2	1	10.3	1	8.4	0.5	6.1	0.5	5.3	
tPHZ	\overline{OE}	A	4.5	2	9	2	9	2	9	2	9	ns
tPLZ			4.5	2	9	2	9	2	9	2	9	
tPHZ	\overline{OE}	B	5.1	1.5	9	1.5	7.8	1	6.4	1	5.9	ns
tPLZ			5.1	1.5	9	1.5	7.8	1	6.4	1	5.9	

switching characteristics over recommended operating free-air temperature range,
 $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
tPLH	A	B	3.6	0.5	6.1	0.5	5	0.5	3.9	0.5	3.5	ns
tPHL			3.6	0.5	6.1	0.5	5	0.5	3.9	0.5	3.5	
tPLH	B	A	2.8	0.5	5.4	0.5	5	0.5	4.7	0.5	4.6	ns
tPHL			2.8	0.5	5.4	0.5	5	0.5	4.7	0.5	4.6	
tPZH	\overline{OE}	A	3.4	1	8.1	1	7.9	1	7.9	1	7.9	ns
tPZL			3.4	1	8.1	1	7.9	1	7.9	1	7.9	
tPZH	\overline{OE}	B	5	0.5	10	0.5	7.9	0.5	5.7	0.5	4.8	ns
tPZL			5	0.5	10	0.5	7.9	0.5	5.7	0.5	4.8	
tPHZ	\overline{OE}	A	4.1	2	7.4	2	7.4	2	7.4	2	7.4	ns
tPLZ			4.1	2	7.4	2	7.4	2	7.4	2	7.4	
tPHZ	\overline{OE}	B	4.9	1.5	8.7	1.5	7.4	1	5.8	1	5.1	ns
tPLZ			4.9	1.5	8.7	1.5	7.4	1	5.8	1	5.1	

SN74AVCH20T245**20-BIT DUAL-SUPPLY BUS TRANSCEIVER****WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS**

SCES567F – MAY 2004 – REVISED APRIL 2005

switching characteristics over recommended operating free-air temperature range,
 $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	B	3.5	0.5	5.8	0.5	4.7	0.5	3.5	0.5	3	ns
t_{PHL}			3.5	0.5	5.8	0.5	4.7	0.5	3.5	0.5	3	
t_{PLH}	B	A	2.7	0.5	4.3	0.5	3.9	0.5	3.5	0.5	3.4	ns
t_{PHL}			2.7	0.5	4.3	0.5	3.9	0.5	3.5	0.5	3.4	
t_{PZH}	\overline{OE}	A	2.5	0.5	5.4	0.5	5.3	0.5	5.2	0.5	5.2	ns
t_{PZL}			2.5	0.5	5.4	0.5	5.3	0.5	5.2	0.5	5.2	
t_{PZH}	\overline{OE}	B	4.8	0.5	9.6	0.5	7.6	0.5	5.3	0.5	4.3	ns
t_{PZL}			4.8	0.5	9.6	0.5	7.6	0.5	5.3	0.5	4.3	
t_{PHZ}	\overline{OE}	A	3	1.1	5.2	1.1	5.2	1.1	5.2	1.1	5.2	ns
t_{PLZ}			3	1.1	5.2	1.1	5.2	1.1	5.2	1.1	5.2	
t_{PHZ}	\overline{OE}	B	4.7	1.2	8.2	1.2	6.9	1	5.3	1	5	ns
t_{PLZ}			4.7	1.2	8.2	1.2	6.9	1	5.3	1	5	

switching characteristics over recommended operating free-air temperature range,
 $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	B	3.4	0.5	5.7	0.5	4.6	0.5	3.4	0.5	2.9	ns
t_{PHL}			3.4	0.5	5.7	0.5	4.6	0.5	3.4	0.5	2.9	
t_{PLH}	B	A	3.3	0.5	3.9	0.5	3.5	0.5	3	0.5	2.9	ns
t_{PHL}			3.3	0.5	3.9	0.5	3.5	0.5	3	0.5	2.9	
t_{PZH}	\overline{OE}	A	2.2	0.5	4.4	0.5	4.3	0.5	4.2	0.5	4.1	ns
t_{PZL}			2.2	0.5	4.4	0.5	4.3	0.5	4.2	0.5	4.1	
t_{PZH}	\overline{OE}	B	4.7	1	9.6	0.5	7.5	0.5	5.1	0.5	4.1	ns
t_{PZL}			4.7	1	9.6	0.5	7.5	0.5	5.1	0.5	4.1	
t_{PHZ}	\overline{OE}	A	3.4	0.8	5	0.8	5	0.8	5	0.8	5	ns
t_{PLZ}			3.4	0.8	5	0.8	5	0.8	5	0.8	5	
t_{PHZ}	\overline{OE}	B	4.6	1.2	8.1	1.2	6.7	1	5.1	0.8	5	ns
t_{PLZ}			4.6	1.2	8.1	1.2	6.7	1	5.1	0.8	5	

SN74AVCH20T245
20-BIT DUAL-SUPPLY BUS TRANSCEIVER
WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS
SCES567F – MAY 2004 – REVISED APRIL 2005

operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	$V_{CCA} = V_{CCB} = 1.2\text{ V}$	$V_{CCA} = V_{CCB} = 1.5\text{ V}$	$V_{CCA} = V_{CCB} = 1.8\text{ V}$	$V_{CCA} = V_{CCB} = 2.5\text{ V}$	$V_{CCA} = V_{CCB} = 3.3\text{ V}$	UNIT
			TYP	TYP	TYP	TYP	TYP	
C_{pdA}^\dagger	A to B	Outputs Enabled	1	1	1	1	2	pF
		Outputs Disabled	1	1	1	1	1	
	B to A	Outputs Enabled	12	13	14	15	16	
		Outputs Disabled	1	1	1	1	1	
C_{pdB}^\dagger	A to B	Outputs Enabled	13	13	14	15	16	pF
		Outputs Disabled	1	1	1	1	1	
	B to A	Outputs Enabled	1	1	1	2	2	
		Outputs Disabled	1	1	1	1	1	

† Power-dissipation capacitance per transceiver

typical total static power consumption ($I_{CCA} + I_{CCB}$)

TABLE 1

V_{CCB}	V_{CCA}						UNIT
	0 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
0 V	0	< 0.5	< 0.5	< 0.5	< 0.5	< 0.5	μA
1.2 V	< 0.5	< 1	< 1	< 1	< 1	1	
1.5 V	< 0.5	< 1	< 1	< 1	< 1	1	
1.8 V	< 0.5	< 1	< 1	< 1	< 1	< 1	
2.5 V	< 0.5	1	< 1	< 1	< 1	< 1	
3.3 V	< 0.5	1	< 1	< 1	< 1	< 1	

TYPICAL CHARACTERISTICS

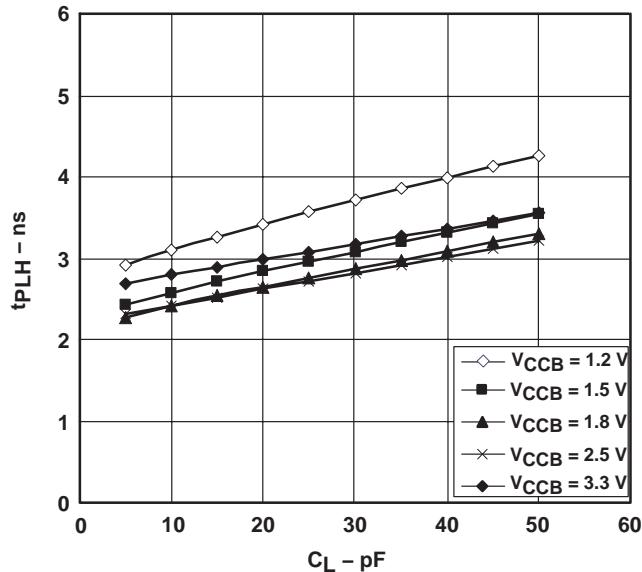
TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE
 $T_A = 25^\circ\text{C}$, $V_{CCA} = 1.2\text{ V}$ 

Figure 1

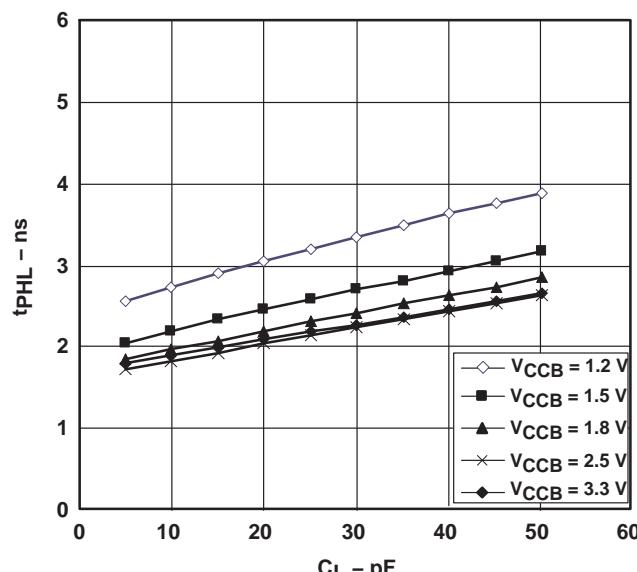


Figure 2

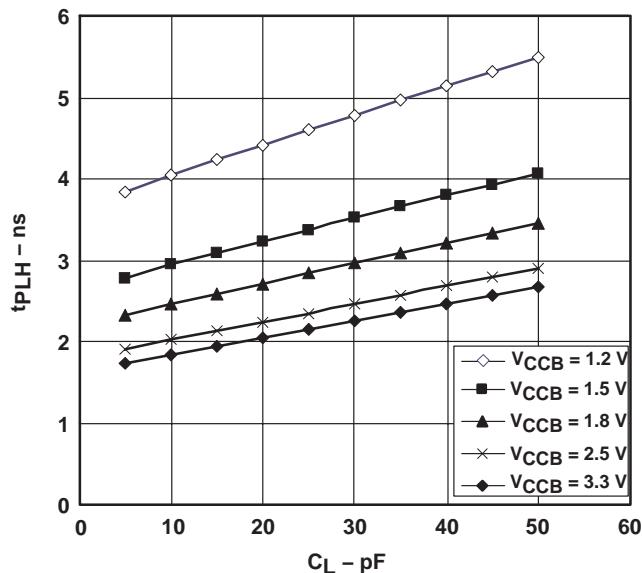
TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE
 $T_A = 25^\circ\text{C}$, $V_{CCA} = 1.5\text{ V}$ 

Figure 3

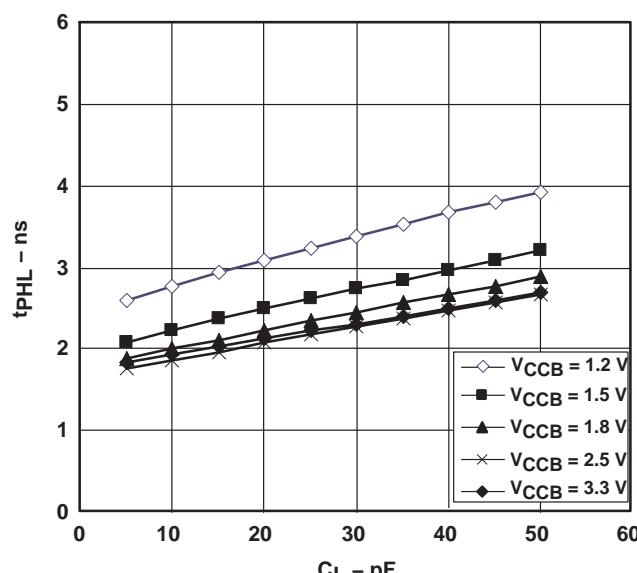


Figure 4

TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE
 $T_A = 25^\circ\text{C}$, $V_{CCA} = 1.8\text{ V}$

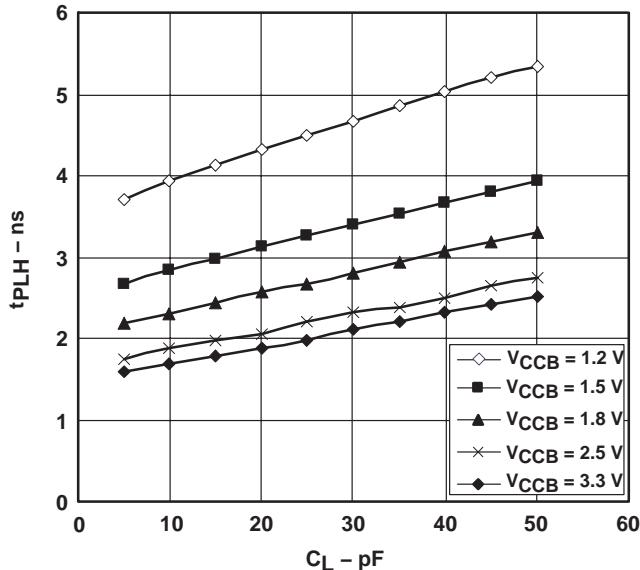


Figure 5

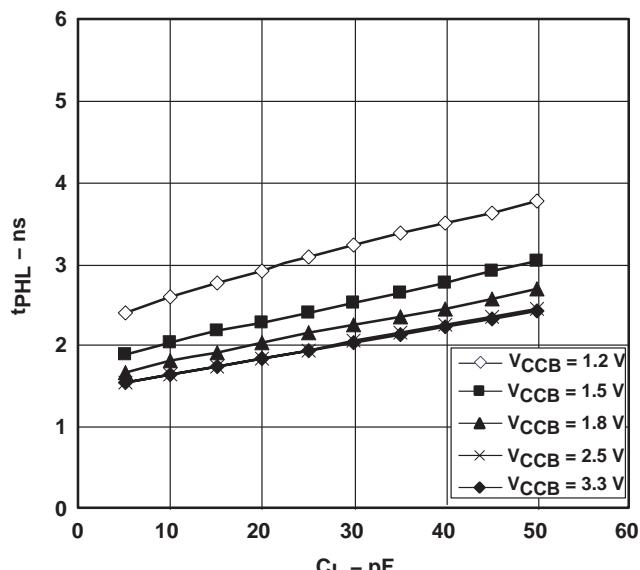


Figure 6

TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE
 $T_A = 25^\circ\text{C}$, $V_{CCA} = 2.5\text{ V}$

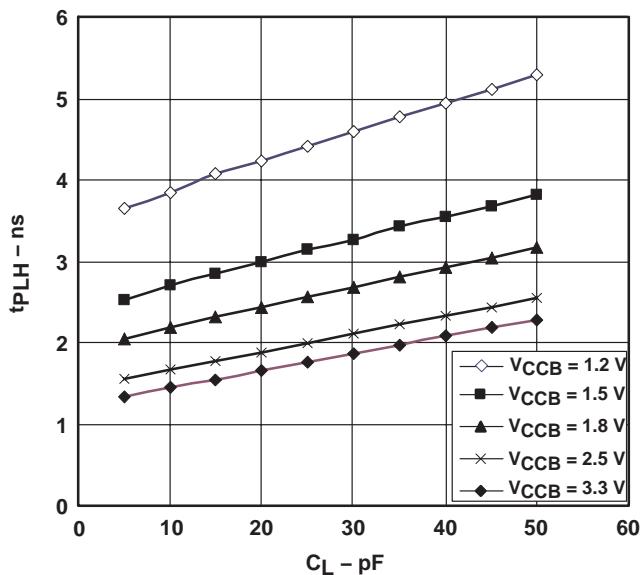


Figure 7

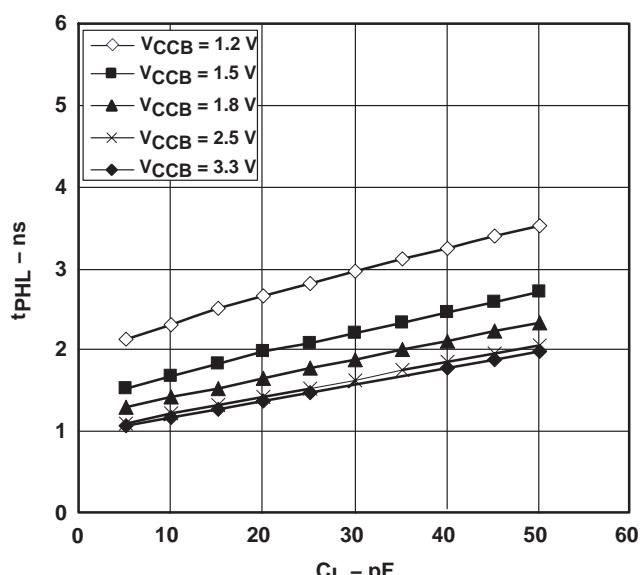


Figure 8

TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE
 $T_A = 25^\circ\text{C}$, $V_{CCA} = 3.3\text{ V}$

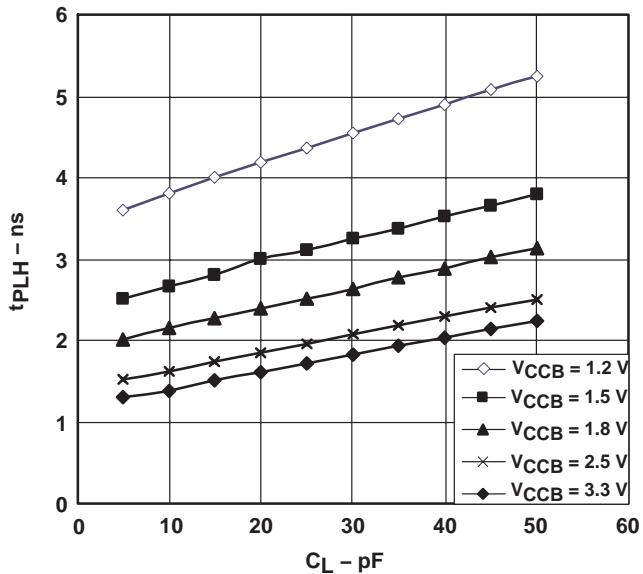


Figure 9

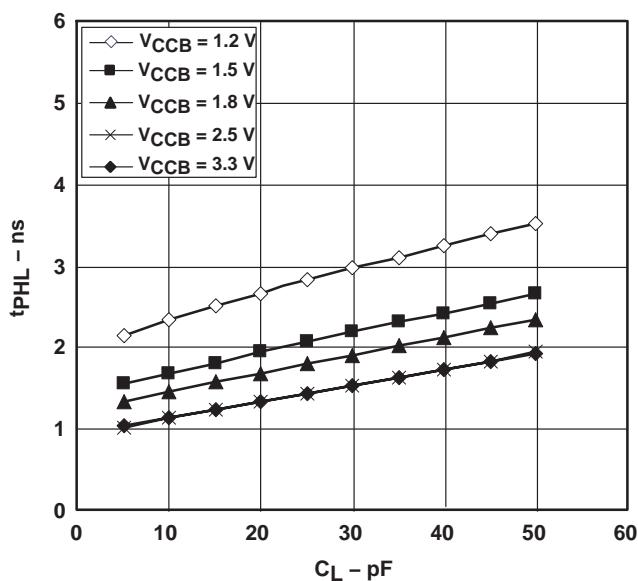
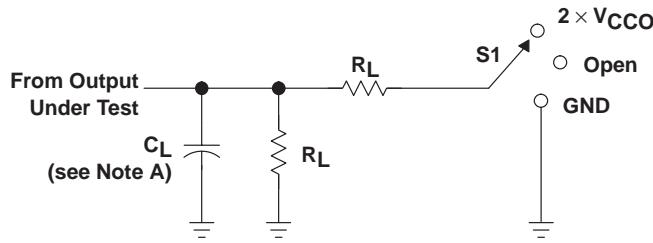


Figure 10

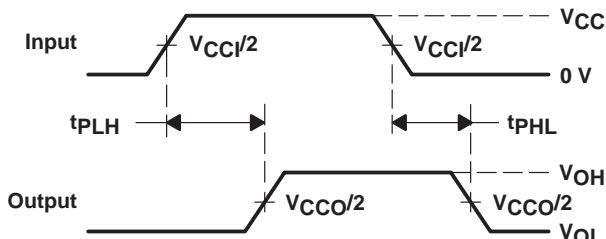
PARAMETER MEASUREMENT INFORMATION



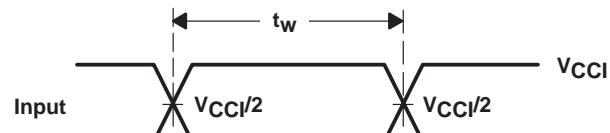
LOAD CIRCUIT

TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CCO}$
t_{PHZ}/t_{PZH}	GND

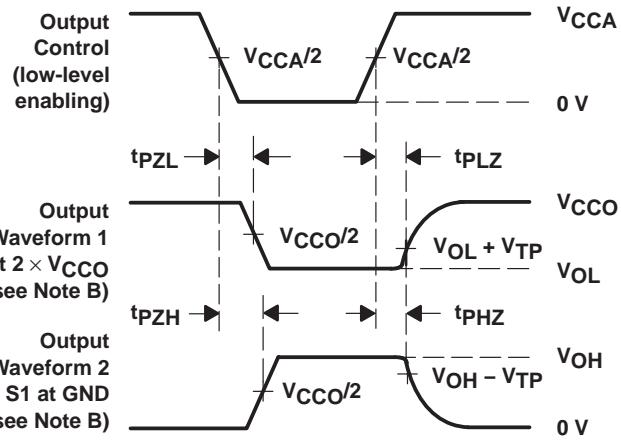
V_{CCO}	C_L	R_L	V_{TP}
1.2 V	15 pF	2 k Ω	0.1 V
$1.5 V \pm 0.1 V$	15 pF	2 k Ω	0.1 V
$1.8 V \pm 0.15 V$	15 pF	2 k Ω	0.15 V
$2.5 V \pm 0.2 V$	15 pF	2 k Ω	0.15 V
$3.3 V \pm 0.3 V$	15 pF	2 k Ω	0.3 V



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

NOTES:

- A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_O = 50 \Omega$, $dv/dt \geq 1$ V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.

Figure 11. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74AVCH20T245GR	Active	Production	TSSOP (DGG) 56	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AVCH20T245
SN74AVCH20T245GR.B	Active	Production	TSSOP (DGG) 56	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AVCH20T245
SN74AVCH20T245VR	Active	Production	TVSOP (DGV) 56	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	WK245
SN74AVCH20T245VR.B	Active	Production	TVSOP (DGV) 56	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	WK245
SN74AVCH20T245VRG4	Active	Production	TVSOP (DGV) 56	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	WK245
SN74AVCH20T245VRG4.B	Active	Production	TVSOP (DGV) 56	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	WK245

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

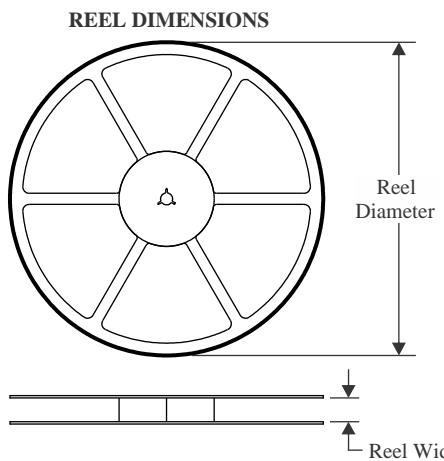
⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

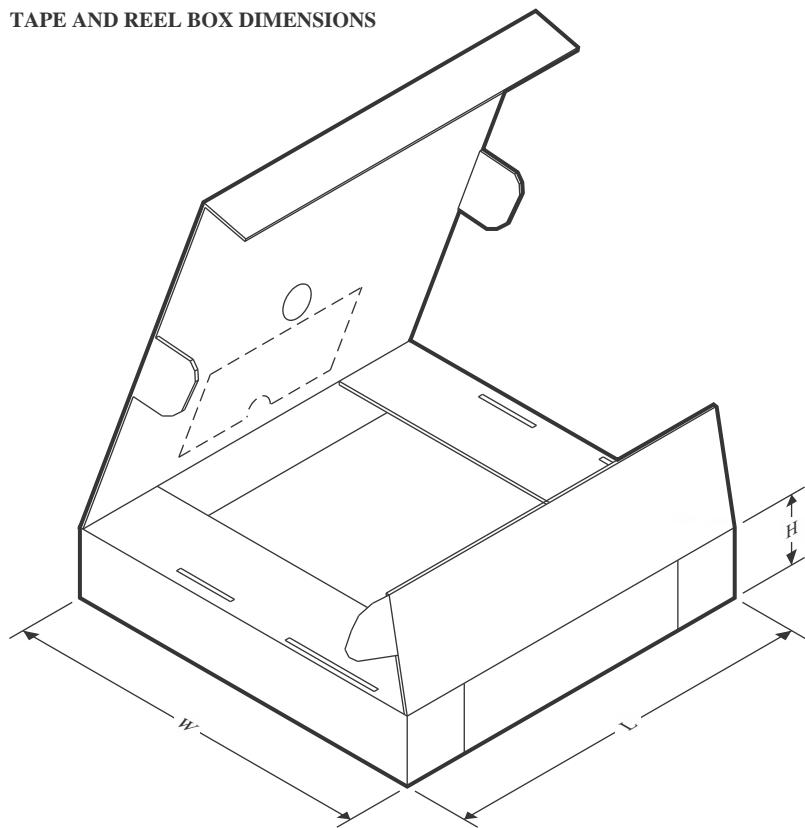
TAPE AND REEL INFORMATION


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AVCH20T245GR	TSSOP	DGG	56	2000	330.0	24.4	8.9	14.7	1.4	12.0	24.0	Q1
SN74AVCH20T245VR	TVSOP	DGV	56	2000	330.0	24.4	6.8	11.7	1.6	12.0	24.0	Q1
SN74AVCH20T245VRG4	TVSOP	DGV	56	2000	330.0	24.4	6.8	11.7	1.6	12.0	24.0	Q1

TAPE AND REEL BOX DIMENSIONS


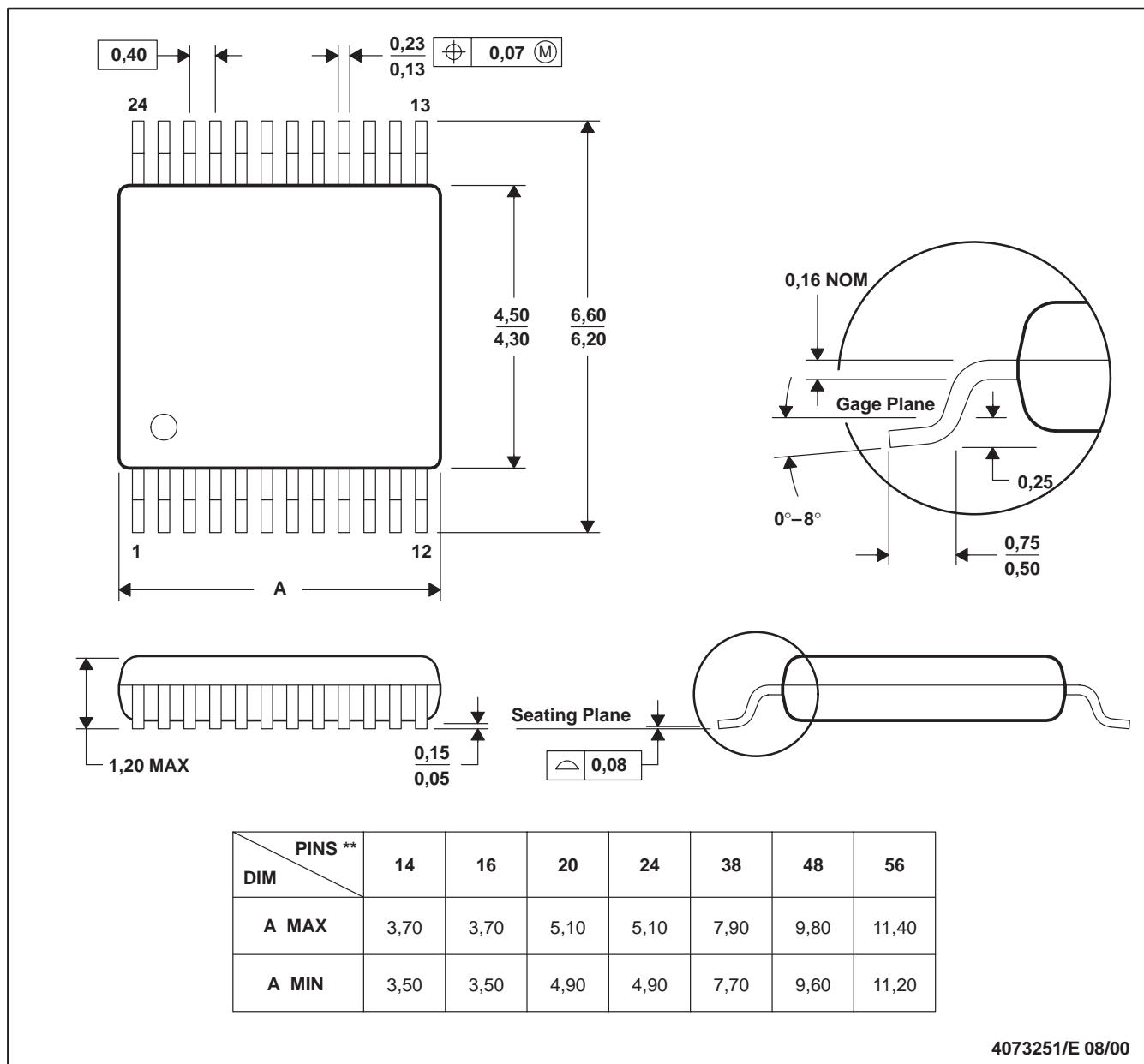
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AVCH20T245GR	TSSOP	DGG	56	2000	356.0	356.0	45.0
SN74AVCH20T245VR	TVSOP	DGV	56	2000	356.0	356.0	45.0
SN74AVCH20T245VRG4	TVSOP	DGV	56	2000	356.0	356.0	45.0

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
D. Falls within JEDEC: 24/48 Pins – MO-153
14/16/20/56 Pins – MO-194

14/16/20/56 Pins – MO-194

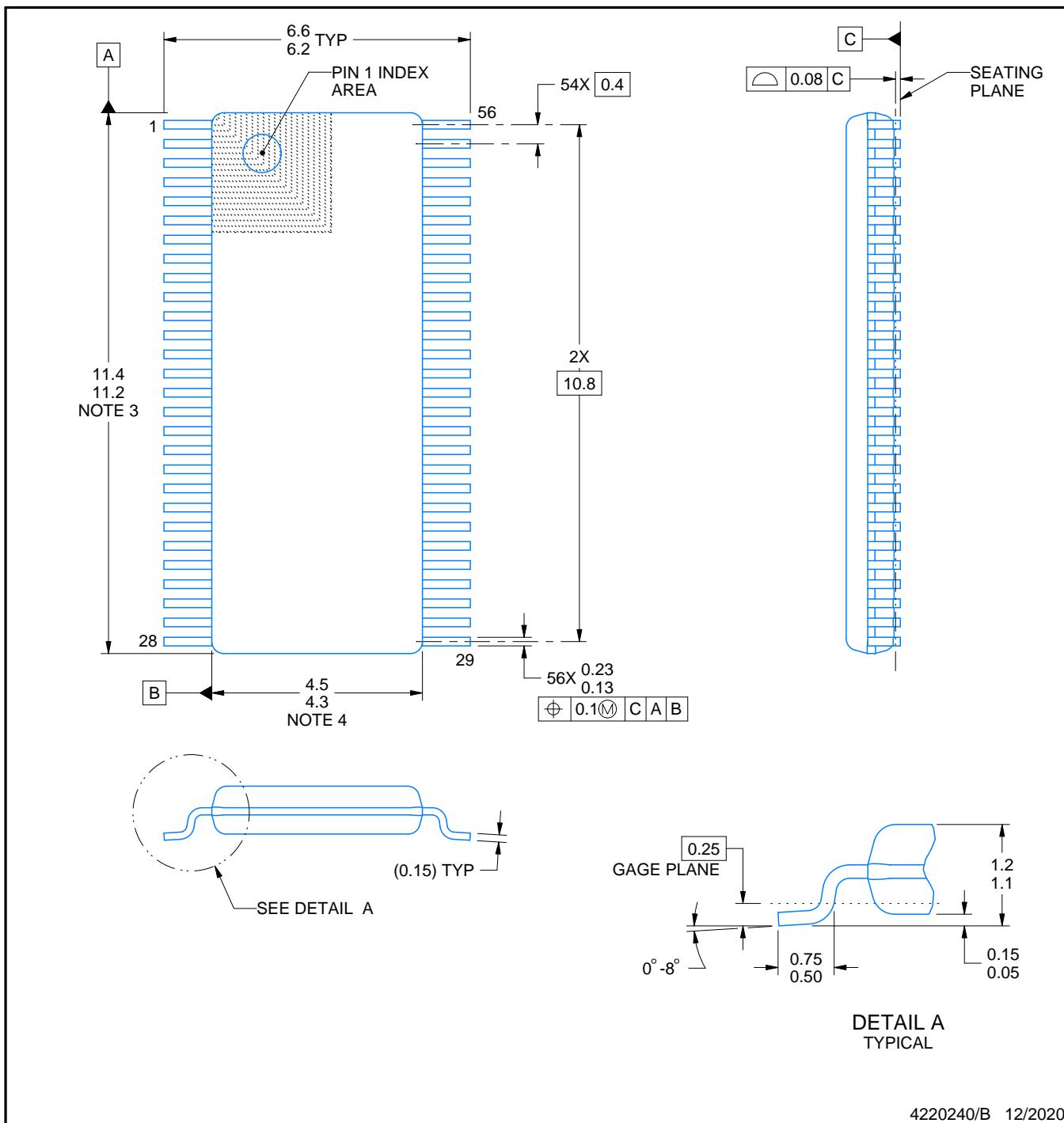
PACKAGE OUTLINE

DGV0056A



TVSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

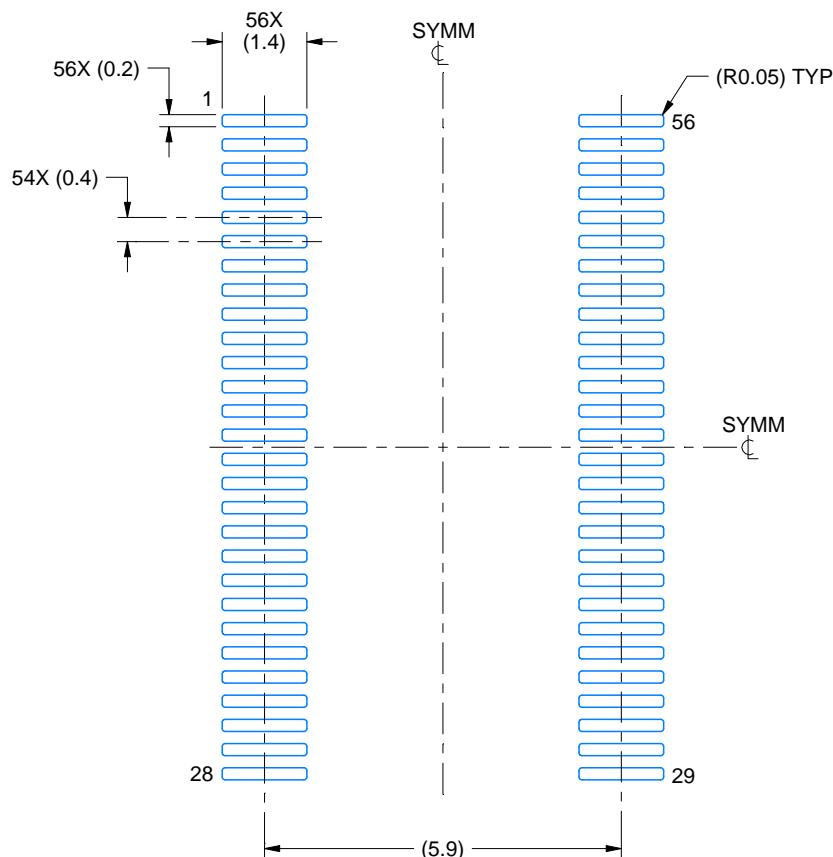
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-194.

EXAMPLE BOARD LAYOUT

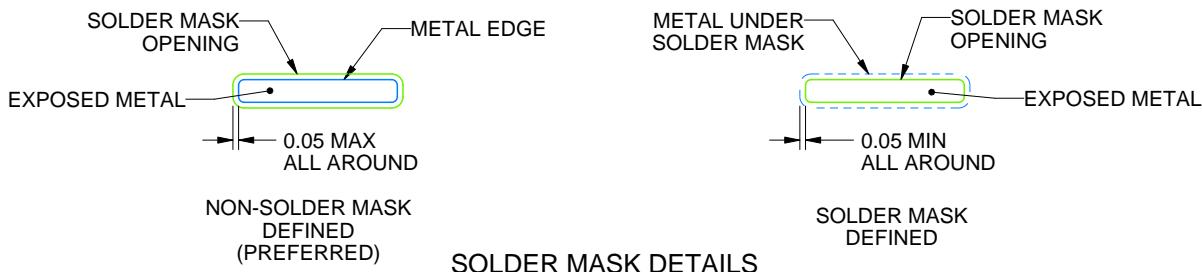
DGV0056A

TVSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 8X



4220240/B 12/2020

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

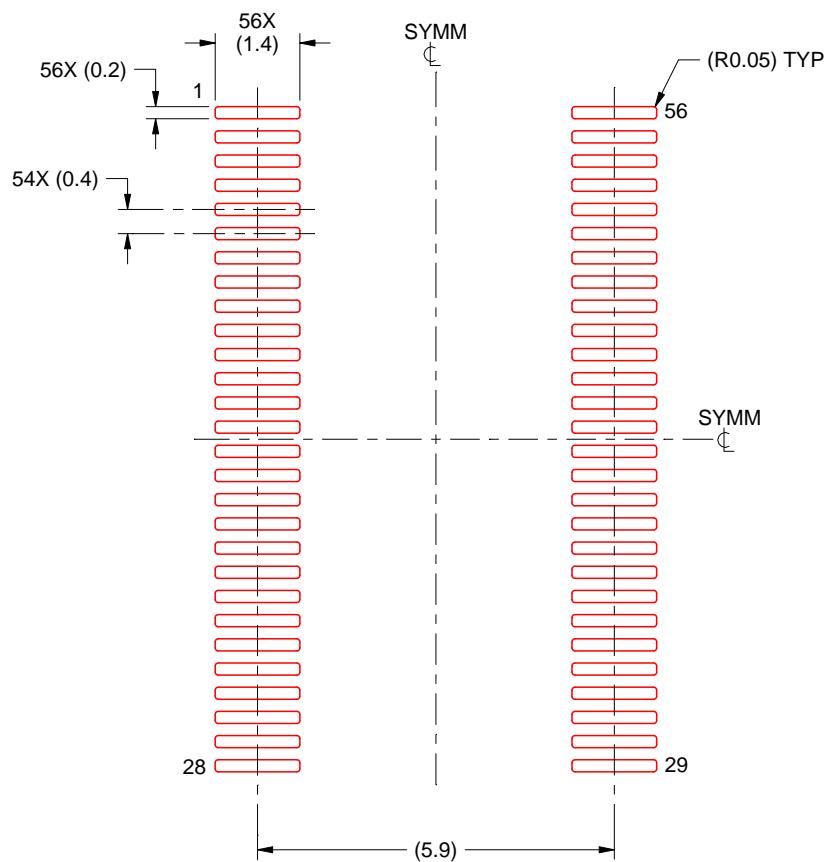
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DGV0056A

TVSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 8X

4220240/B 12/2020

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

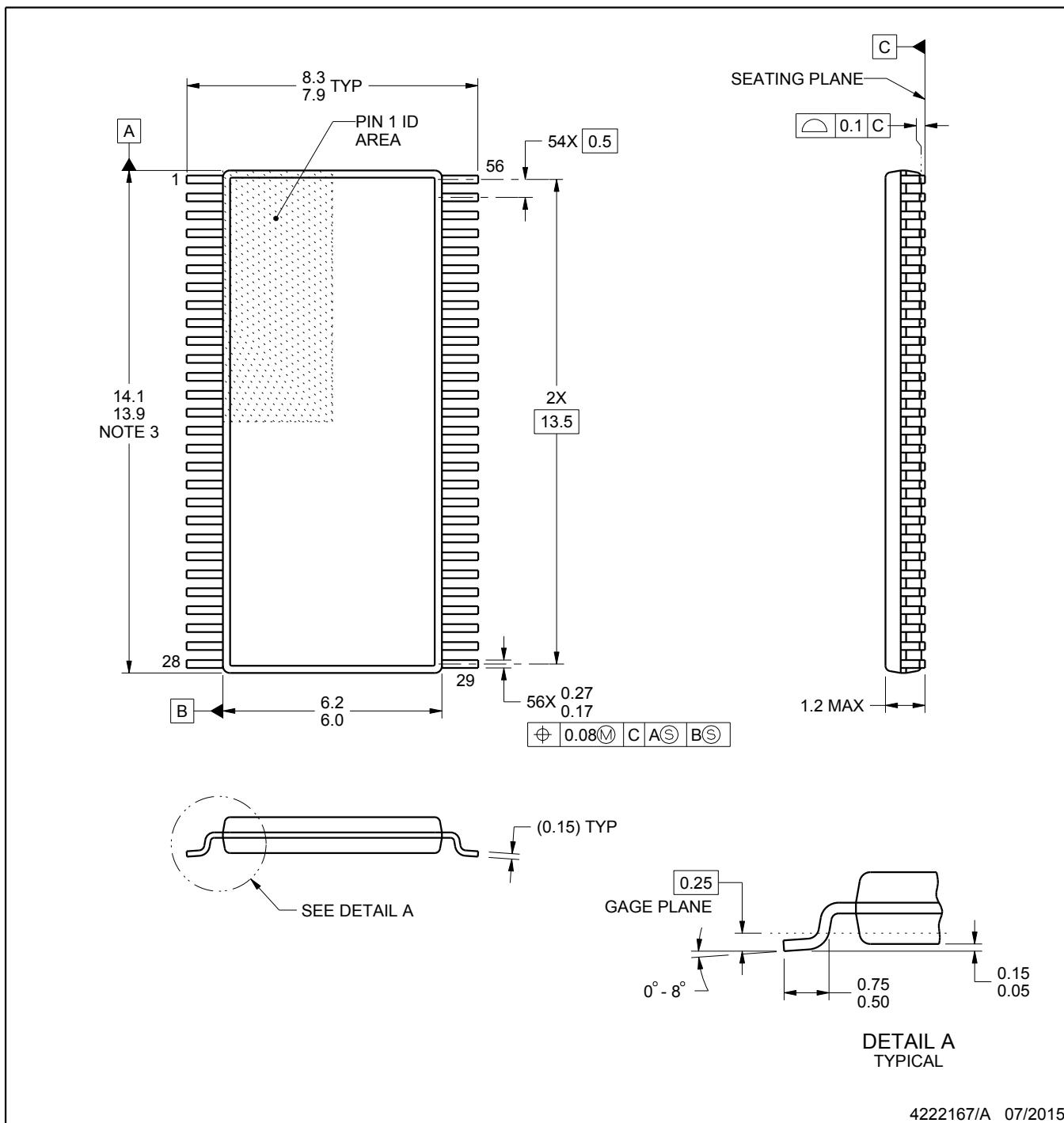
PACKAGE OUTLINE

DGG0056A



TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

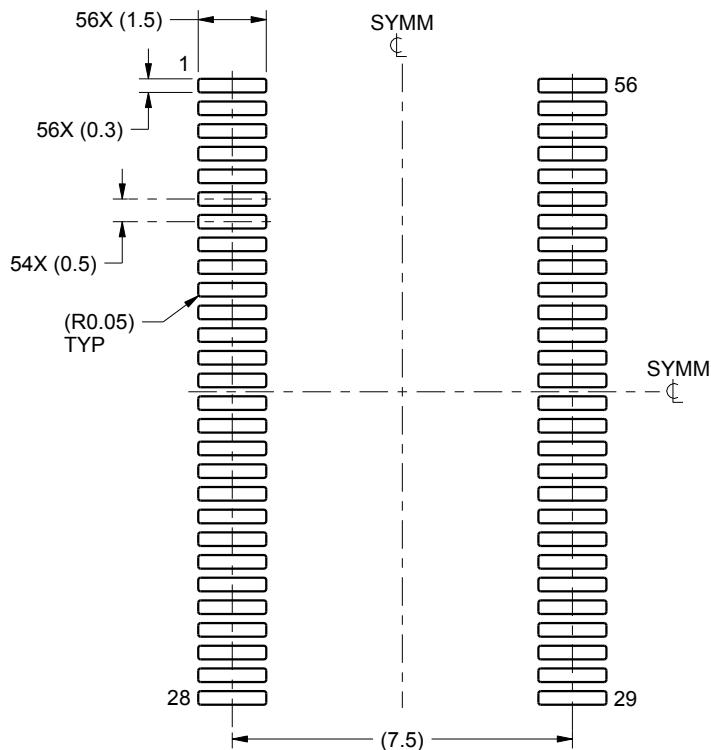
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

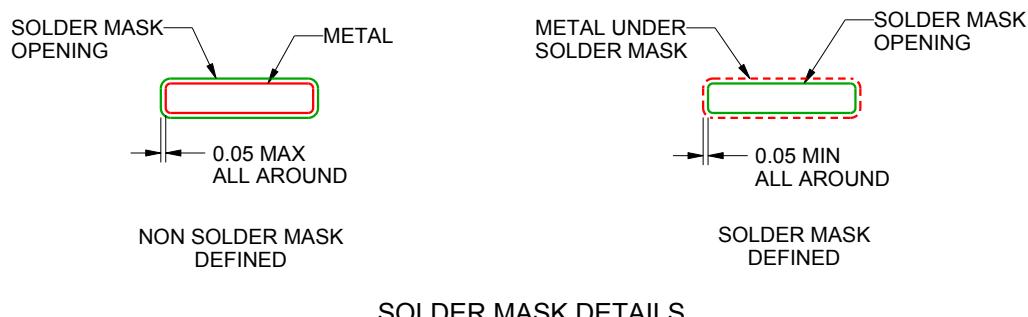
DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

4222167/A 07/2015

NOTES: (continued)

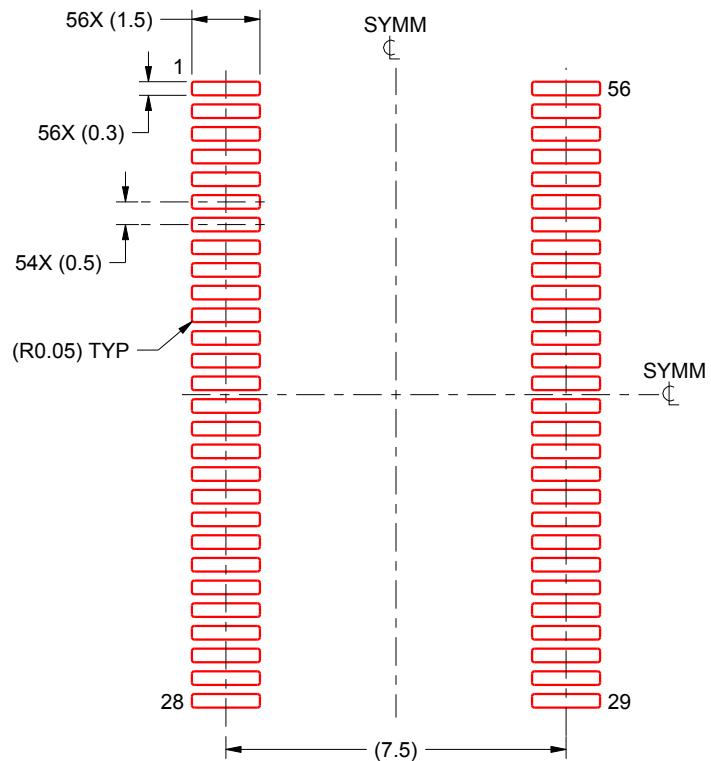
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4222167/A 07/2015

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](#) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2025, Texas Instruments Incorporated